

Navy Case No. 83647

## NEAR FIELD PROBE

## BACKGROUND OF THE INVENTION

## 1. Field of the Invention

5           The present invention relates generally to a probe for testing components of an electromagnetic radiating system. More specifically, the present invention relates to a near field probe in an antenna coupler that is designed to test installed components of an electromagnetic radiating system by  
10           coupling from the system to perform the test.

## 2. Description of the Prior Art.

          There is currently a need for a near field probe for use in testing installed components of an electromagnetic radiating system on the SM-1 missile. Specifically, the probe should be  
15           designed to provide an accurate voltage response as a function of frequency for the radiating system on the SM-1 missile when the probe is positioned in the SM-1 DC coupler.

          The probe previously used to test the components of the radiating system for the SM-1 missile had serious reliability  
20           problems in that the probe's diode detectors would fail and were very expensive to replace. Further, there is no longer a manufacturer for the probe, necessitating a more reliable but less costly replacement for the probe.

### SUMMARY OF THE INVENTION

The present invention overcomes some of the disadvantages of the prior art in that it comprises an inexpensive, highly reliable and very accurate near field probe for testing installed components of an electromagnetic radiating system on the SM-1 missile. The probe design comprises a dipole antenna with a balun. The probe utilizes a dual diode arrangement which provides approximately twice the output voltage as compared to the previous probe. The probe may then be placed further away from the antenna under test to achieve the same voltage output so that manufacturing tolerances are not critical. Since the output voltage is doubled, the previous probe's problem of providing a marginal voltage output is alleviated.

### BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is an electrical schematic diagram illustrating the near field probe comprising a preferred embodiment of the present invention;

FIG. 2 is a view illustrating the connectors and probe antenna positions for the near field probe of FIG. 1;

FIG. 3 is an electrical schematic diagram which shows the coax cables for the probe of FIG. 1 positioned inside of the

SM-1 DC coupler which terminates with a pair of output  
connectors J1 and J2;

FIG. 4 depicts a scaled drawing of the near field probe of  
FIG. 1; and

5        FIGS. 5 and 6 are plots illustrating frequency response  
curves for test data provided by the near field probe of  
FIG. 1.

#### DETAILED DESCRIPTION OF A PREFERRED EMBODIMENT OF THE INVENTION

10        Referring first to FIGS. 1, and 3, there is shown a near  
field probe, designated generally by the reference numeral 10,  
for testing installed components of an electromagnetic  
radiating system on the SM-1 missile. The near field probe is  
mounted on microstrip printed circuit board 12.

15        The near field probe 10 includes a dipole antenna 14  
having a balun 16. Balun 16, which is a transmission line  
transformer, is connected to header connector J1(H) of circuit  
board 12, pins 1 and 2, as shown in FIG. 1. Header connector  
J1(H) allows for ease of installation and removal of the  
antenna 14 of near field probe 10.

20        A diode detector 17 consisting of a pair of Schottky

diodes D1A and D1B is integrated into near field probe 10. The anode of diode D1A is connected to antenna element/dipole 20 of dipole antenna 14 and the cathode of diode D1A is connected to antenna element/dipole 18 of dipole antenna 14. The anode of diode D1B is connected to antenna element 18 of dipole antenna 14 and the cathode of diode D1A is connected to balun 16.

By utilizing diodes D1A and D1B configured as shown in FIG. 1, the output of near field probe 10 is approximately double that of the probe used in the past. This allows the user to place probe 10 further away from the antenna being tested to achieve the same voltage output so that manufacturing tolerances are not as critical. Since the output voltage is doubled by utilizing diodes D1A and D1B the problem of marginal voltage output is alleviated.

The near field probe 10 also includes a load resistor R1 mounted on printed circuit board 12 which eliminates two printed circuit boards by the connectors J1 and J2 (FIG. 3) used in previous couplers.

The probe diode antenna length is approximately a half wavelength consisting of antenna elements 18 and 20 with each antenna element approximately a quarter wavelength as shown in FIG. 1. Diode D1A rectifies one half of the RF (radio frequency) signal and this voltage is on the top side of the

probe as shown in FIG. 1. Diode D1B and capacitor C1 rectify the other half of the RF signal. From an AC (alternating current) perspective, diodes D1A and D1B are in parallel connected across the two sides of the probe's dipole antenna which results in a symmetrical load. From a DC (direct current) perspective, the rectified voltage from diode D1A is added to the rectified voltage from diode D1B producing a voltage doubling of the DC voltage. Resistor R1 is the load resistor since the monitoring resistance does not contribute to the load because the monitoring resistance has substantially higher value than resistor R1.

A ground cannot be placed on either side of diodes D1A and D1B which necessitates the use of balun 16 to isolate the RF signal from a grounding position. Balun 16 has an efficiency of 98 to 99% which insures high signal strength for near field probe 10. Capacitor C4 is positioned at the electrical signal output or the end of balun 16 to function as an AC short circuit.

The ground for the probe is placed at the connectors J1 and J2 in the manner illustrated in FIG. 3 to minimize ground loops. This ground potential is transmitted through coax cables 22 and 24 to one side of capacitor C4. Capacitor C3 is included in the near field probe 10 to integrate the

electromagnetic or RF signal detected by probe 10 and reduces noise within the detected RF signal. Capacitors C1 and C4, which are 20 picofarad capacitors function better as RF short circuits than capacitor C3 which is a 0.01 microfarad capacitor with a higher impedance at RF. The load resistor R1 has a  
5 variable impedance value ranging from 137 ohms to 3.56K ohms.

Referring to FIGS. 2 and 3, FIG. 3 shows the coax cables 22 and 24 inside of the SM-1 DC coupler which terminates with output connectors J1 and J2. A lug is used to ground the  
10 return lines to an enclosure at one of the connector attachment screws. A view of the connectors and probe antenna positions is illustrated in FIG. 2.

Referring to FIGS. 1-4, FIG. 4 depicts a scaled drawing of the probe 10. The overall length of the probe is 2.50 inches and the width is 1.15 inches. The length of the dipole antenna  
15 14 was adjusted to obtain the flattest response across the frequency being measured at each probe position. The left side and the right side of the dipole antenna were trimmed from the antenna's original length of 2.5 inches.

20 The probe 10 is fabricated using conventional and well known printed circuit board technology. A one ounce copper single side printed circuit mounted on a 0.062 inch thick FR4 epoxy fiberglass board.

Table I below sets forth the configuration for the probe  
verses position in the SM-1 DC coupler 26 with the positions  
being illustrated in FIG. 2. As shown in FIG. 2, six of the  
probes having mounting positions which are identical, while two  
5 of the probes having mounting positions which are reversed.  
This reversal occurs because of the design of coupler 26 and  
measuring system and provides for the best electrical  
performance by the probes. The left and right sides for the  
two reversed positions are different from the remaining probes  
10 which were not reversed.

Table I  
Probe Configuration Versus Position

Probe Position	Pin Connection	Probe Configuration	Load Resistor
1	J1-A	Trim 0.3" left 0.25" right	143
2	J1-B	No Trimming	1.96K
3	J1-C	Trim 0.3" left 0.3" right	221
4	J1-D	No Trimming	383
5	J2-D	Trim 0.3" left 0.25" right	137
6	J2-C	No Trimming	3.56K
7	J2-B	Trim 0.3" left 0.3" right	301
8	J2-A	Trim 0.3" left 0.25" right	188

To test the near field probe, three models of the probe antenna were fabricated. The only difference in the probes was the height dimension of antenna which as shown in FIG. 4 is 0.95 inches. The other models had antenna height dimensions of 1.05 inches and 1.15 inches. The probe model illustrated in FIG. 4 provided the best response in terms of constant voltage across the frequency band under test and adequate magnitude of voltage. The probe model illustrated in FIG. 4 also allowed for maximum distance between the antenna being tested and the probe. This yields the best result with respect to alignment of the probe model illustrated in FIG. 4.

Two different dual diode models were used in the probe antennas. Models Numbers HSMS-2822 and HSMS-2862 dual diodes,



commercially available from Hewlett-Packard of Palo Alto, California were used in the design of the near field probe. The specifications for the dual diodes were similar except that the HSMS-2822 dual diode has a minimum breakdown voltage of 4  
5 volts with a maximum capacitance of 1 picofarad while the HSMS-2862 dual diode has a minimum breakdown voltage of 4 15 volts with a maximum capacitance of 0.35 picofarads. High breakdown voltage is very desirable because of problems associated with diode failure. However, a lower breakdown voltage yields a  
10 smaller capacitance to minimize detected voltage variations versus frequency. It was found that the smaller capacitance of the HSMS-2862 dual diode did yield a little more detected voltage but did not significantly minimize voltage variation versus frequency when compared to the HSMS-2822 dual diode.

15 Accordingly, the HSMS-2822 dual diode was used in the design of near field probe 10 since there was more than sufficient voltage detected and the 15 volt breakdown voltage provides at least a seven times reliability margin over other diodes used. The HSMS-2822 dual diode were tested at power  
20 levels exceeding 10 watts with detected voltages in excess of 12 volts without any failures.

The following tuning test results are provides as to the tuning response at each probe position illustrated in FIG. 2

without a dielectric cover which was removed for ease in removing and replacing antenna probes.

Probe 10 electrically connected to connector J1-A (FIGS. 2 and 3) provided a good low-end frequency response, limited at the high end and the antenna was trimmed as shown in Table I to bring up the high end response.

Probe 10 electrically connected to connector J1-B (FIGS. 2 and 3) provided a good response, therefore no tuning was required.

Probe 10 electrically connected to connector J1-C (FIGS. 2 and 3) provided a very drop off at the high end of the frequency response, and the antenna was trimmed as shown in Table I to bring up the high end response.

Probe 10 electrically connected to connector J1-D (FIGS. 2 and 3) provided an unusual peak in the response at the center of the band but the response was acceptable, therefore no tuning was required.

Probe 10 electrically connected to connector J2-D (FIGS. 2 and 3) provided a good low-end frequency response, limited at the high end and the antenna was trimmed as shown in Table I to bring up the high end response.

Probe 10 electrically connected to connector J2-C (FIGS. 2 and 3) provided a good response, therefore no tuning was

required.

Probe 10 electrically connected to connector J2-B (FIGS. 2 and 3) provided a good low-end frequency response, limited at the high end and the antenna was trimmed as shown in Table I to bring up the high end response.

Probe 10 electrically connected to connector J2-A (FIG. 3) provided a good low-end frequency response, limited at the high end and the antenna was trimmed as shown in Table I to bring up the high end response.

In addition, it was found that the probe (untrimmed) in free space yields a broad response that is centered at the frequency being measured.

The probe tests were run and the data taken is set forth in Tables II and III below with Table II being a test of the SM-1 DC coupler 26 without a dielectric cover and Table III being a test of the SM-1 DC coupler 26 with a dielectric cover. As is evident the test run with the dielectric cover is better, both in output voltage and in flatness across the frequency band.

Table II

Test Data at 1.7 watts without cover

Freq. MHZ	Probe J1-A	Probe J1-B	Probe J1-C	Probe J1-D	Probe J2-D	Probe J2-C	Probe J2-B	Probe J2-A
2212.5	1.87	1.99	2.99	1.96	1.98	1.48	2.83	2.19
2224.5	1.49	1.83	2.65	2.76	1.80	1.56	2.67	2.45
2232.5	1.31	1.52	2.47	3.17	1.65	1.37	2.47	2.48
2252.5	1.45	1.85	2.61	2.80	1.53	1.03	2.01	2.39
2262.5	1.53	1.77	2.56	2.03	1.55	0.98	1.82	2.28
2272.5	1.53	1.57	2.36	1.39	1.53	0.86	1.59	2.07
2272.5	1.52	1.59	2.27	1.23	1.51	0.84	1.50	1.97

Table III

Test Data at 1.7 watts with cover

Freq. MHZ	Probe J1-A	Probe J1_B	Probe J1-C	Probe J1-D	Probe J2-D	Probe J2-C	Probe J2-B	Probe J2-A
2212.5	2.07	2.84	3.07	2.24	2.16	2.30	3.48	2.45
2224.5	1.65	2.52	2.77	2.80	1.92	2.39	3.34	2.83
2232.5	1.53	2.17	2.70	2.95	1.71	2.38	3.14	2.93
2252.5	1.48	2.26	2.79	3.02	1.52	2.55	2.70	2.75
2262.5	1.59	2.59	2.69	2.45	1.62	2.76	2.44	2.52
2272.5	1.68	2.72	2.38	1.78	1.69	2.90	2.09	2.20
2272.5	1.71	2.84	2.24	1.57	1.69	2.95	1.96	2.07

The desired performance for the probe is to obtain a minimum of 1 volt at 1.7 watts. In general this was accomplished. The minimum voltage is significantly above 1 volt because the Coupler was tuned from 2.2 to 2.3 GHz and the 0.6 dB loss in the input cable was not added to the power output. The SM-1 DC coupler has a requirement that the antenna under test be measured at 4 watts and the data provided is set

forth in Tables IV and V below.

Table IV

Test Data at 4.0 watts without cover

	Freq. MHZ	Probe J1-A	Probe J1-B	Probe J1-C	Probe J1-D	Probe J2-D	Probe J2-C	Probe J2-B	Probe J2-A
5	2212.5	2.98	3.81	4.52	3.63	3.09	2.94	4.33	3.54
	2224.5	2.43	3.73	4.06	4.88	2.84	3.15	4.10	3.93
	2232.5	2.15	3.38	3.77	5.40	2.60	3.04	3.77	3.92
10	2252.5	2.39	3.92	3.97	4.95	2.48	3.09	3.19	3.80
	2262.5	2.50	3.92	3.91	3.75	2.51	3.06	2.92	3.60
	2272.5	2.48	3.61	3.61	2.67	2.44	2.78	2.55	3.24
	2272.5	2.48	3.67	3.51	2.42	2.43	2.76	2.44	3.13

Table V

Test Data at 4.0 watts with cover

	Freq. MHZ	Probe J1-A	Probe J1-B	Probe J1-C	Probe J1-D	Probe J2-D	Probe J2-C	Probe J2-B	Probe J2-A
20	2212.5	3.61	5.56	5.03	4.47	3.70	4.59	5.67	4.36
	2224.5	2.92	5.01	4.61	5.43	3.33	4.87	5.47	5.01
	2232.5	2.64	4.30	4.39	5.69	2.95	4.80	5.15	5.05
25	2252.5	2.69	4.99	4.58	5.98	2.74	5.25	4.62	4.72
	2262.5	2.88	5.49	4.42	5.07	2.91	5.52	4.22	4.29
	2272.5	3.00	5.63	3.93	3.81	2.97	5.60	3.66	3.74
	2272.5	3.07	5.85	3.77	3.46	2.98	5.73	3.49	3.59

Referring to FIGS. 5 and 6, FIGS. 5 and 6 depict continuous test data versus frequency for the near field probe 10 where Tables II, III, IV and V are discrete points. Specifically, FIG. 5 illustrates the data which was measured for a coupler without a dielectric cover and FIG. 6 illustrates the data which was measured for a coupler with a dielectric

cover.

From the foregoing, it is readily apparent that the present invention comprises a new, unique and exceedingly useful near field probe which constitutes a considerable improvement over the known prior art. Many modifications and variations of the invention are possible in light of the above teachings. It is therefore to be understood that within the scope of the appended claims that the invention may be practiced otherwise than as specifically described.

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